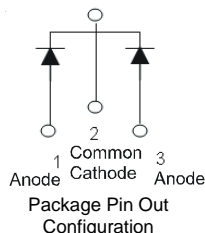


**Features**

- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Note 2)**
- **Also Available in Green Molding Compound (Note 5)**

**Mechanical Data**

- Case: TO-220AB
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 <sup>(83)</sup>
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 1.85 grams (approximate)

**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	100	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>RM</sub>		
Average Rectified Output Current @ T <sub>C</sub> = 150°C	I <sub>O</sub>	40	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	235	A
Isolation Voltage (ITO-220AB Only) From terminal to heatsink t = 3 sec.	V <sub>AC</sub>	2000	V

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance (per leg)	R <sub>θJC</sub>	2	°C/W
Thermal Resistance Junction to Case (Note 3)			
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop (per leg)	V <sub>F</sub>	-	0.67 0.60	0.72 0.64	V	I <sub>F</sub> = 20A, T <sub>J</sub> = 25°C I <sub>F</sub> = 20A, T <sub>J</sub> = 125°C
Leakage Current (Note 1)	I <sub>R</sub>	-	-	0.5 40	mA	V <sub>R</sub> = 100V, T <sub>J</sub> = 25°C V <sub>R</sub> = 100V, T <sub>J</sub> = 125°C

- Notes:
1. Short duration pulse test used to minimize self-heating effect.
  2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes*.

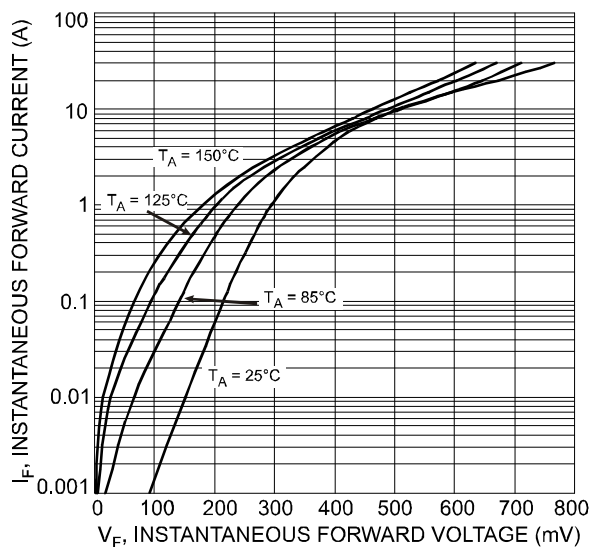


Fig. 1 Typical Forward Characteristics

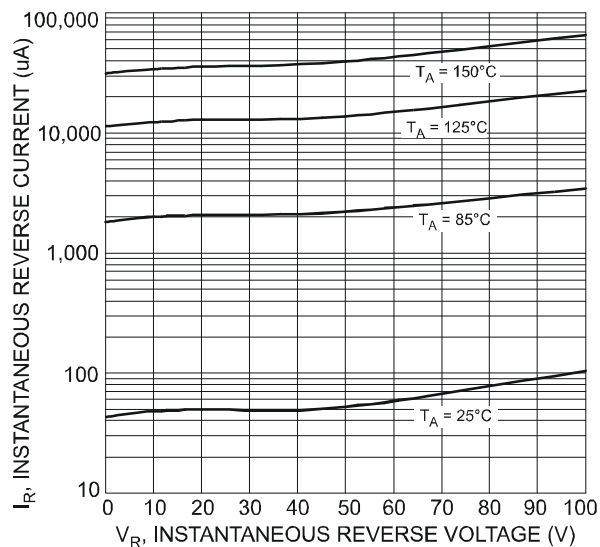


Fig. 2 Typical Reverse Characteristics

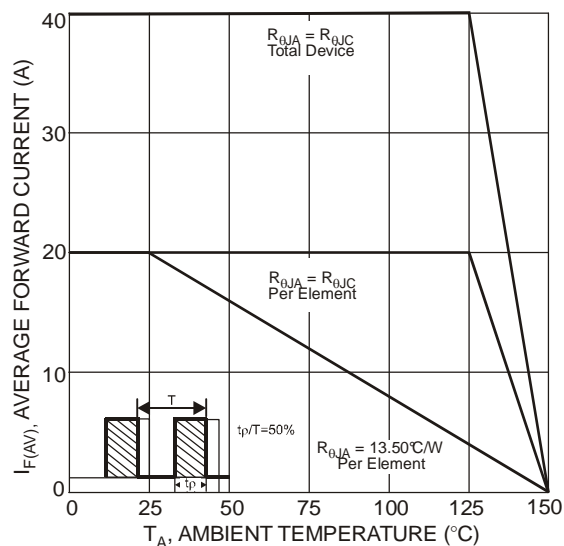


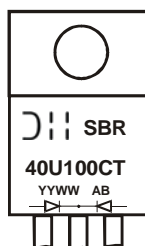
Fig. 3 Forward Current Derating Curve

## Ordering Information (Notes 3 and 4)

Part Number	Case	Packaging
SBR40U100CT	TO-220AB	50 pieces/tube
SBR40U100CT-G	TO-220AB	50 pieces/tube

- Notes:
3. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.
  4. For Green Molding Compound version part numbers, add "-G" suffix to part number above. Examples: SBR40U100CT-G

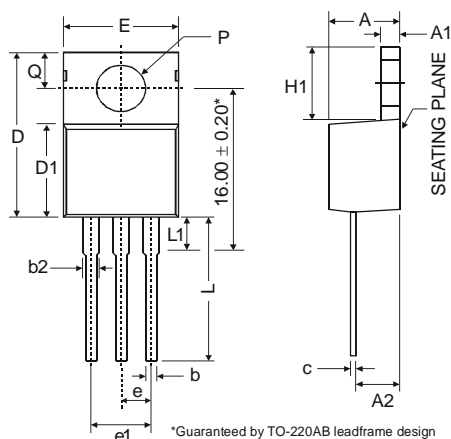
## Marking Information



SBR40U100CT = Product Type Marking Code  
 AB = Foundry and Assembly Code  
 YYWW = Date Code Marking  
 YY = Last two digits of year (ex: 07 = 2007)  
 WW = Week (01-52)

SBR is a registered trademark of Diodes Incorporated.

## Package Outline Dimensions



TO-220AB			
Dim	Min	Typ	Max
A	3.56	-	4.82
A1	0.51	-	1.39
A2	2.04	-	2.92
b	0.39	0.81	1.01
b2	1.15	1.24	1.77
c	0.356	-	0.61
D	14.22	-	16.51
D1	8.39	-	9.01
e	2.54		
e1	5.08		
E	9.66	-	10.66
H1	5.85	-	6.85
L	12.70	-	14.73
L1	-	-	6.35
P	3.54	-	4.08
Q	2.54	-	3.42
All Dimensions in mm			

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